## **UNITED STATES**

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1803 tog 11	
Docket No.:	

COMBINED DECLADATI	ON/POWER OF ATTOR	NEV EOD HTH HTV/DE	SICN PATENT APPLICATION

As a below named inventor, I here			
My residence, post office address a		v next to my name. ame is listed below) or an original, first and joint	inventor (if plural names are
listed below) of the subject matter		patent is sought on the invention entitled:	inventor (if plurar names are
the specification of which is attached	ed hereto, unless the following bo		ho- and
was filed on (if applicable).	as United States Application	n Number or PCT International Application Num	ber and
I hereby state that I have reviewed amendment referred to above.	and understand the contents of th	e above-identified specification, including the cla	ims, as amended by any
	information which is material to	patentability as defined in 37 CFR § 1.56.	
		(d) or § 365(b) of any foreign application(s) for p	
application on which priority is cla		s) for patent or inventor's certificate having a filing	ig date before that of the
Prior Foreign Application(s)			Priority Not Claimed
2002-226493	JAPAN	2 AUGUST 2002	·
(Number)	(Country)	Day/Month/Year Filed	
(Number)	(Country)	Day/Month/Year Filed	_
I hereby claim the benefit under 35	U.S.C. § 120 or § 119(e) of any	United States application(s), or § 365(c) of any I	
		at matter of each of the claims of this application is matter of each of the claims of this application is	
information which is material to pa	tentability as defined in 37 CFR	§ 1.56 which became available between the filing	
the national or PCT International fi	ling date of this application.		
(Application Serial No.)	(Eiling Date)	(5)	Cara da a
(Application Serial No.)	(Filing Date)	(Status patented, pend	ing, adandoned)
(Application Serial No.)	(Filing Date)	(Status patented, pend	ing shandoned)
(Application Schai No.)	(1 milg Date)	(Status patented, pend	ing, avaidoned)
I hereby appoint the attorneys and a business in the Patent and Tradema	•	er USPTO Customer No. 21,171 to prosecute thi	s application and to transact all
ousiness in the Patent and Tradema	TK Office confiected therewith.		
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	PATE	NT TRADEMARK OFFICE	
be true; and further that these state	ements were made with the know ion 1001 of Title 18 of the Unite	dge are true and that all statements made on infoveledge that willful false statements and the like so d States Code and that such willful false statements.	o made are punishable by fine or
Full name of sole or first inventor		A	
Inventor's Signature	7 didea Shim	ada Date 3 /	
		Citizenship J	,
Mailing AddressC/O ENPLAS	CORPORATION, 30-1 Na	amiki 2-chome, Kawaguchi-shi,	Saitama-ken 332-003 JAPAN
Full name of second joint inventor,	if any		JAPAN
Second Inventor's Signature		Date	
Residence		Citizenship	

Additional inventors are being named on separately numbered sheets attached hereto.